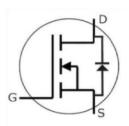


Wolfspeed SiC Gen 4 MOSFET

Description

This is the Wolfspeed's 4th generation of high performance silicon carbide MOSFET in a packageless bare die format to be implemented into any custom module design. The high blocking voltage with low on-resistance, high speed switching with low capacitance make this MOSFET ideal for high frequency switching application including solar inverters and EV chargers.





Package Types: Bare Die PN's: CPM4-0120-0149JS0A

Features

- Enhanced 4th Generation SiC MOSFET
- High blocking voltage with low on-resistance
- High speed switching with low capacitance
- Fast intrinsic diode with low reverse recovery

Applications

- EV Chargers
- Server & Telecom PSU
- UPS
- Solar Inverters
- SMPS
- DC/DC Converters

Absolute Maximum Ratings

Stress beyond those listed under absolute maximum ratings may damage the device.

Parameter	Symbol		Rating	Unit
Drain-Source Voltage, across Tvj	VDS(max)		1200	V
Maximum Gate-Source Voltage, Peak Transient Capability	VGS(max)		-8/+19	V
Continuous Drain Current, VGS = 15V, assumes die packaged	ID	Tc = 25°C	90	А
in TO-247 package with Rth(j−c) < 0.63 K/W	טו	Tc = 100°C	67	
Pulsed Drain Current, tp limited by Tvj(max)	ID(pulse)		152	Α
Virtual Junction and Storage Temperature	TVJ, Tstg		-55 to +175	°C
Maximum Processing Temperature, in non-reactive ambient	Tproc		325	°C

Recommended Operating Conditions

Parameter	Symbol	Rating	Unit
Recommended Operating Gate - Source Voltage	V _{GS(op)}	-4/+15	V

Electrical Characteristics (T_{VJ} = 25°C)

Characteristics	Symbol	Min.	Тур.	Max.	Unit	Test Conditions
Drain-Source Breakdown Voltage	V _{(BR)DSS}	1200			V	$V_{GS} = 0 \text{ V}, I_D = 100 \mu\text{A}$
	V _{GS(th)}	1.8	2.7	3.6	V	V _{DS} = V _{GS} , I _{DS} = 10.7 mA
Gate Threshold Voltage			2.2		V	V _{DS} = V _{GS} , I _{DS} = 10.7 mA, T _{VJ} = 175°C
Zero Gate Voltage Drain Current	IDSS		1	50	μΑ	V _{DS} = 1200 V, V _{GS} = 0 V
Gate-Source Leakage Current	Igss		10	250	nA	V _{GS} = 15 V, V _{DS} = 0 V
D : 6 O 61 I D : I	_	18.2	26	33.8	mΩ	$V_{GS} = 15 \text{ V}, I_D = 38 \text{ A}$
Drain-Source On-State Resistance	R _{DS(on)}		49			$V_{GS} = 15 \text{ V}, I_D = 38 \text{ A}, T_{VJ} = 175^{\circ}\text{C}$
Transconductance	gfs		33		- S	V _{DS} = 20 V, I _{DS} = 38 A
			33			V _{DS} = 20 V, I _{DS} = 38 A, T _{VJ} = 175°C
Input Capacitance	Ciss		3470			V = 0 V V = 1000 V
Output Capacitance	Coss		110			$V_{GS} = 0 \text{ V}, V_{DS} = 1000 \text{ V}$ f = 100 kHz
Reverse Transfer Capacitance	Crss		9]	V _{AC} = 25 mV
Coss Stored Energy	E _{oss}		68		μJ	V _{DS} = 1000 V, f = 100 kHz
Internal Gate Resistance	R _{G(int)}		4.1		Ω	f = 1 kHz, V _{AC} = 25 mV
Gate to Source Charge	Qgs		35		nC	V _{DS} = 800 V, V _{GS} = -4 V/15 V
Gate to Drain Charge	Q _{gd}		38			l _{DS} = 38 A
Total Gate Charge	Qg		136			Per IEC60747-8-4 pg 21

Reverse Diode Characteristics (T_{VJ} = 25 °C)

Characteristics	Symbol	Тур.	Max.	Unit	Test Conditions	
Diode Forward Voltage	V _{SD}	4.8		V	V _{GS} = -4 V, I _{SD} = 19.5 A	
		4.3		V	$V_{GS} = -4 \text{ V}, I_{SD} = 19.5 \text{ A}, T_{VJ} = 175 ^{\circ}\text{C}$	
Reverse Recovery Time	trr	56		ns		
Reverse Recovery Charge	Qrr	590		nC	$V_{GS} = -4 \text{ V}, I_{SD} = 38 \text{ A}, V_{R} = 800 \text{ V}$ dif/dt = 4750 A/ μ s, $T_{VJ} = 175 ^{\circ}\text{C}$	
Peak Reverse Recovery Current	Irrm	34		А		

Typical Performance

All the graphs are based on a die placed in a TO-247-4L package.

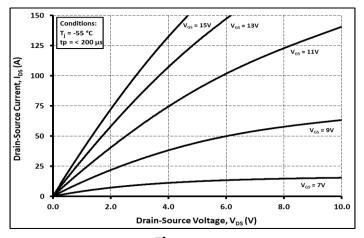


Figure 1.

Output Characteristics T_{vj} = -55 °C

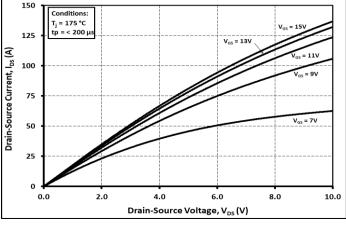


Figure 3.

Output Characteristics T_{vj} = 175 °C

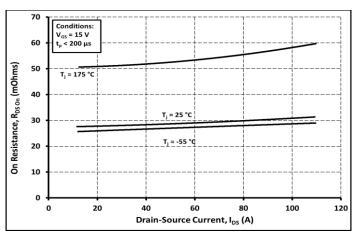


Figure 5.

On-Resistance vs. Drain Current For Various Temperatures

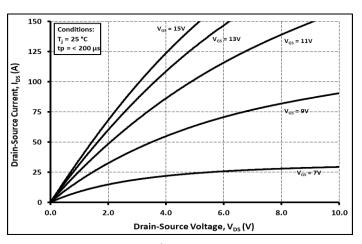


Figure 2.

Output Characteristics $T_{vj} = 25$ °C

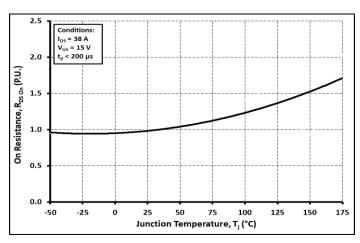


Figure 4.

Normalized On-Resistance vs. Temperature

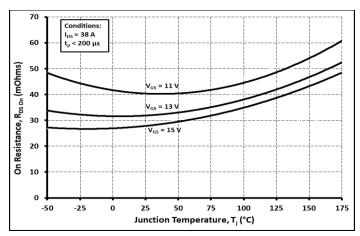


Figure 6.

On-Resistance vs. Temperature For Various Gate Voltages

Typical Performance

All the graphs are based on a die placed in a TO-247-4L package.

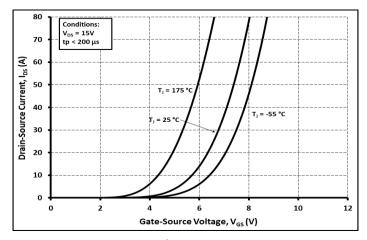


Figure 7.

Transfer Characteristic For Various Junction Temperatures

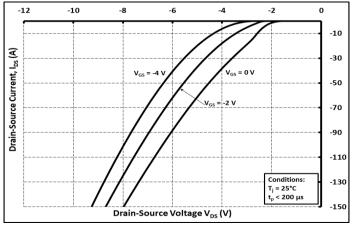


Figure 9.

Body Diode Characteristic at T_{vj} = 25 °C

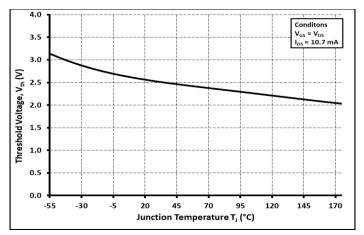


Figure 11.

Threshold Voltage vs. Temperature

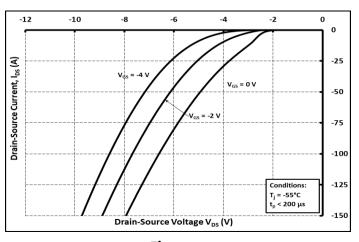


Figure 8.

Body Diode Characteristic at T_{vi} = -55 °C

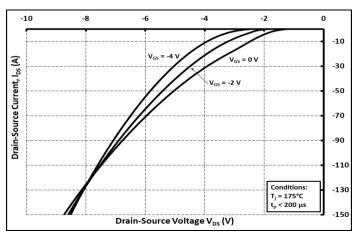


Figure 10.

Body Diode Characteristic at T_{vj} = 175 °C

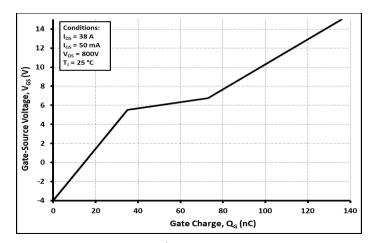


Figure 12.

Gate Charge Characteristics

Typical Performance

All the graphs are based on a die placed in a TO-247-4L package.

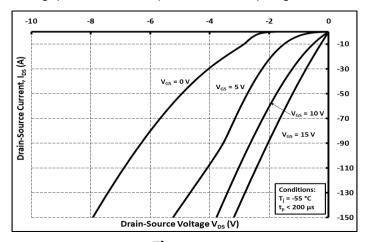


Figure 13.

3rd Quadrant Characteristic at T_{vj} = -55 °C

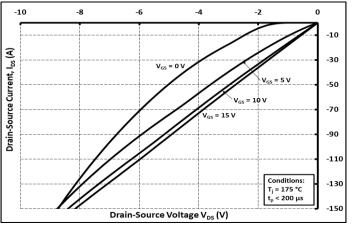


Figure 15.

3rd Quadrant Characteristic at T_{vj} = 175 °C

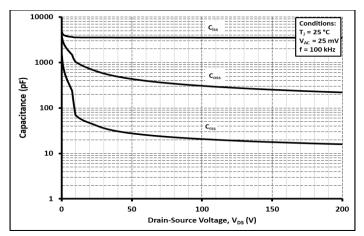


Figure 17.

Capacitances vs. Drain-Source Voltage (0-200V)

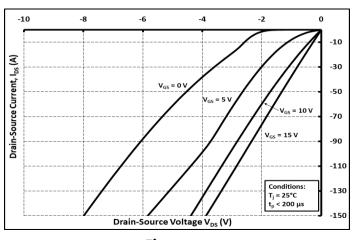


Figure 14.

3rd Quadrant Characteristic at T_{vj} = 25 °C

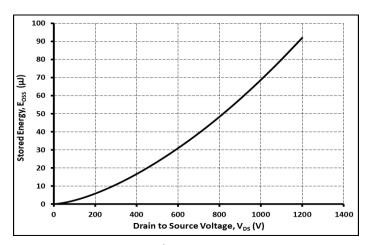


Figure 16.

Output Capacitor Stored Energy

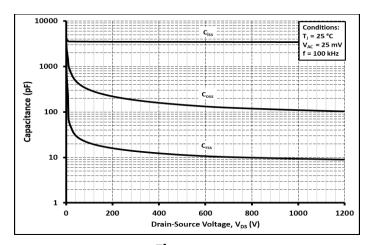


Figure 18.

Capacitances vs. Drain-Source Voltage (0-1200V)

Product Ordering Information

Order Number	Description	Package
CPM4-0120-0149JS0A-FY6	SiC MOSFET G4 IND 1200V/26mO UV MLT	Bare Die Product

Revision History

The information in this document is subject to change without notice.

Revision History	Date of Change	Brief Summary
3	1/1/2024	Final Datasheet Release

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